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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

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Details	
Product Status	Obsolete
Core Processor	M16C/60
Core Size	16-Bit
Speed	20MHz
Connectivity	I ² C, IEBus, SIO, UART/USART
Peripherals	DMA, POR, PWM, Voltage Detect, WDT
Number of I/O	71
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	4K x 8
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 24x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	80-LQFP
Supplier Device Package	80-LQFP (12x12)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/m30280f8hp-u7b

Email: info@E-XFL.COM

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1.2 Performance Overview

Table 1.1 and 1.2 outline performance overview of the M16C/28 Group (M16C/28, M16C/28B).

Table 1.1	M16C/28 Group	(M16C/28,	, M16C/28)	Performance	(80/85-Pin Package)
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	Item	Performance			
CPU	Number of basic instructions	91 instructions			
	Minimum instruction	41.7 ns (f(BCLK) = 24 MHz, Vcc = 4.2 V to 5.5 V) (M16C/28B)			
	excution time	50 ns (f(BCLK) = 20 MHz, Vcc = 3.0 V to 5.5 V) (M16C/28, M16C/28B)			
		100 ns (f(BCLK) = 10 MHz, Vcc= 2.7 V to 5.5 V) (M16C/28, M16C/28B)			
	Operation mode	Single chip mode			
	Address space	1M bytes			
	Memory capacity	See Table 1.3			
Peripheral	I/O port	Input/Output : 71 lines			
Function	Multifunction timer	TimerA:16 bits x 5 channels, TimerB:16 bits x 3 channels			
		Three-phase Motor Control Timer			
		TimerS (Input Capture/Output Compare)			
		: 16bit base timer x 1 channel (Input/Output x 8 channels)			
	Serial I/O	2 channels (UART0, UART1)			
		UART, clock synchronous			
		1 channel (UART2)			
		UART, clock synchronous, I ² C bus ⁽¹⁾ , or IEbus ⁽²⁾			
		2 channels (SI/O3, SI/O4)			
		Clock synchronous			
		1 channel (Multi-Master I ² C bus ⁽¹⁾)			
	A/D converter	10 bits x 24 channels			
	DMAC	2 channels			
	Watchdog timer	15 bits x 1 (with prescaler)			
	Interrupt	25 internal and 8 external sources, 4 software sources, 7 levels			
	Clock generation circuit	4 circuits			
		• Main clock (*)			
		• Sub-clock (*)			
		On-chip oscillator			
		PLL frequency synthesizer			
		(*) Equipped with a built-in feedback resistor			
	Oscillation Stop Detect	Main clock oscillation stop, re-oscillation detect function			
	Function				
	Voltage detection circuit	Available			
Electrical	Power supply voltage	Vcc = 4.2 V to 5.5 V (f(BCLK) = 24 MHz) (M16C/28B)			
Characteristics		Vcc = 3.0 V to 5.5 V (f(BCLK) = 20 MHz) (M16C/28, M16C/28B)			
		Vcc = 2.7 V to 5.5 V (f(BCLK) = 10 MHz) (M16C/28, M16C/28B)			
	Power consumption	16 mA (Vcc = 5V, f(BCLK) = 20 MHz)			
		$25 \mu\text{A}$ (f(XCIN) = 32 KHz on RAM)			
		$3.0 \mu\text{A} (\text{Vcc} = 3\text{V}, \text{f}(\text{XCIN}) = 32 \text{ KHz}, \text{ in wait mode})$			
		0.7 μ A (Vcc = 3V, in stop mode)			
Flash Memory	Program/erase supply voltage	2.7 V to 5.5 V			
	Program and erase endurance	100 times (all space) or 1,000 times (Blocks 0 to 5)			
		/10,000 times (Block A, Block B ⁽³⁾)			
Operating Am	bient Temperature	-20 to 85°C/-40 to 85°C ⁽³⁾			
Package	-	80-pin plastic mold LQFP, 85-pin plastic mold TFLGA			
NOTES					

NOTES:

1. I²C bus is a trademark of Koninklijke Philips Electronics N. V.

2. IEBus is a trademark of NEC Electronics Corporation.

3. Refer to **Table 1.5** to **1.7** for number of program/erase.

4. Use PLL frequency synthesizer to use M16C/28B at f(BCLK) = 24 MHz.

Table 1.2	M16C/28 Group (M16C/28,	M16C/28)	(64-Pin Package)
	mileo/20 0104p (mileo/20)		(of i mi i donago)

	Item	Performance		
CPU	Number of basic instructions	91 instructions		
	Minimum instruction	41.7 ns (f(BCLK) = 24 MHZ, VCC = 4.2 V to 5.5 V) (M16C/28B)		
	excution time	50 ns (f(BCLK) = 20 MHZ, VCC = 3.0V to 5.5V) (M16C/28, M16C/28B		
		100 ns (f(BCLK) = 10 MHZ, VCC = 2.7V to 5.5V) (M16C/28, M16C/28B		
	Operation mode	Single chip mode		
	Address space	1M bytes		
	Memory capacity	See Table 1.3		
Peripheral	I/O Port	Input/Output : 55 lines		
Function	Multifunction timer	TimerA:16 bits x 5 channels, TimerB:16 bits x 3 channels		
		Three-phase Motor Control Timer		
		TimerS (Input Capture/Output Compare)		
		: 16bit base timer x 1 channel (Input/Output x 8 channels)		
	Serial I/O	2 channels (UART0, UART1)		
		UART, clock synchronous		
		1 channel (UART2)		
		UART, clock synchronous, I ² C bus ⁽¹⁾ , or IEbus ⁽²⁾		
		1 channels (SI/O3, SI/O4)		
		Clock synchronous		
		1 channel (Multi-Master I ² C bus ⁽¹⁾)		
	A/D converter	10 bits x 13 channels		
-	DMAC	2 channels		
	Watchdog timer	15 bits x 1 (with prescaler)		
	Interrupt	24 internal and 8 external sources, 4 software sources, 7 levels		
	Clock generation circuit	4 circuits		
		Main clock(*)		
		• Sub-clock(*)		
		On-chip oscillator		
		PLL frequency synthesizer		
		(*) Equipped with a built-in feedback resistor		
	Oscillation Stop Detect	Main clock oscillation stop, re-oscillation detect function		
	Function			
	Voltage detection circuit	Available		
Electrical	Power supply voltage	Vcc = 4.2 V to 5.5 V (f(BCLK) = 24 MHz) (M16C/28)		
Characteristics		Vcc = 3.0 V to 5.5 V (f(BCLK) = 20 MHz) (M16C/28, M16C/28B)		
		Vcc = 2.7 V to 5.5 V (f(BCLK) = 10 MHz) (M16C/28, M16C/28B)		
	Power consumption	16 mA (Vcc = 5 V, f(BCLK) = 20 MHz)		
		25 μ A (f(XCIN) = 32 KHz on RAM)		
		3.0 μ A (VCC = 3 V, f(XCIN) = 32 KHz, in wait mode)		
		0.7 μ A (Vcc = 3 V, in stop mode)		
Flash Memory	Program/erase supply voltage	2.7 V to 5.5 V		
	Program and erase endurance	100 times (all space) or 1,000 times (Blocks 0 to 5)		
		/10,000 times (Block A, Block B ⁽³⁾)		
Operating Am	bient Temperature	-20 to 85C°/-40 to 85C° ⁽³⁾		
Package		64-pin plastic mold LQFP		

NOTES:

1. I²C bus is a trademark of Koninklijke Philips Electronics N. V.

2. IEBus is a trademark of NEC Electronics Corporation.

3. Refer to Table 1.5 to 1.7 for number of program/erase.

4. Use PLL frequency synthesizer to use M16C/28B at f(BCLK) = 24 MHz.

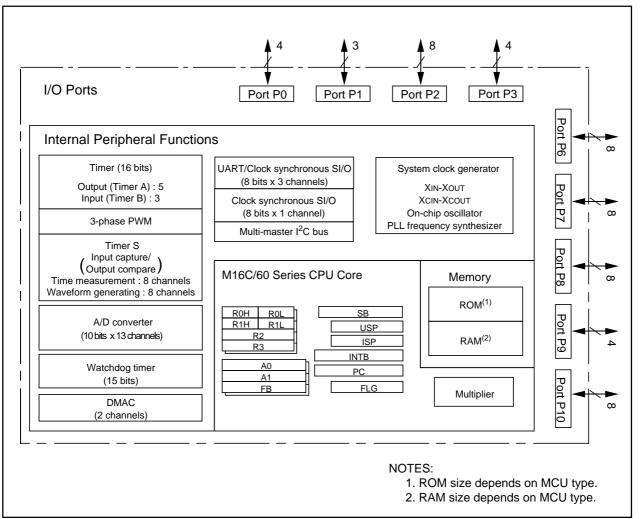


Figure 1.2 M16C/28 Group (M16C/28, M16C/28B), 64-Pin Block Diagram

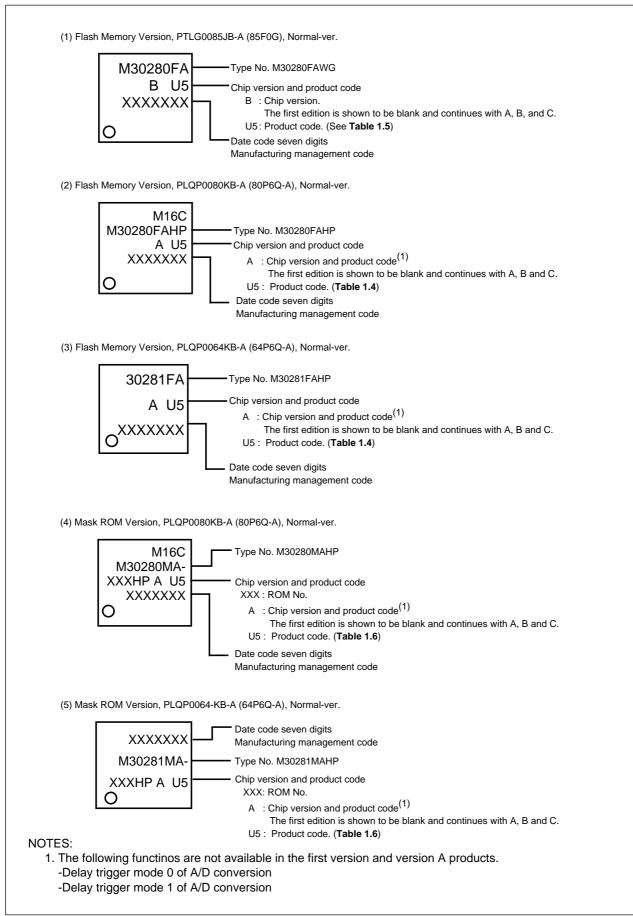


Figure 1.4 Marking Diagram-M16C/28 Normal-ver.

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1.5 Pin Assignment

Figures 1.5 to 1.7 show the pin Assignments (top view).

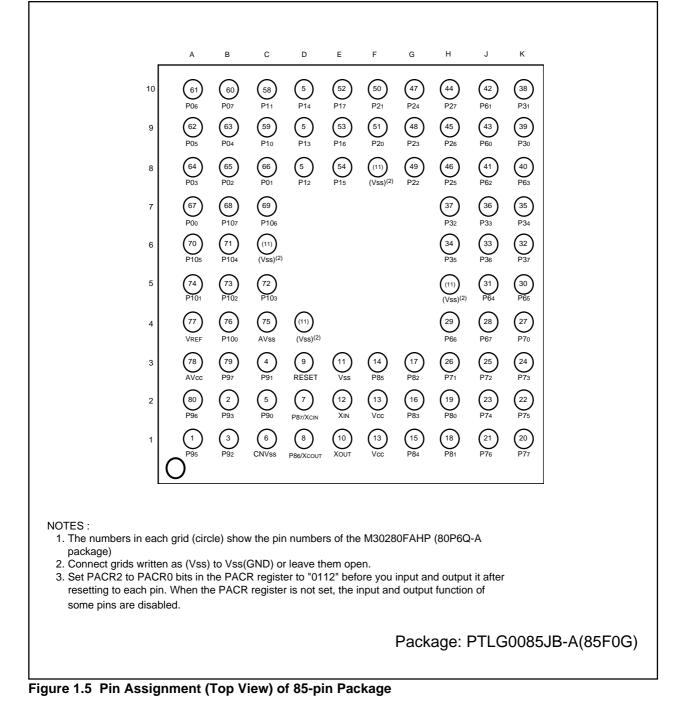


Table 1.8 Pin Characteristics for 85-pin Package (continued)

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	Timer S Pin	UART Pin	Multi-master I ² C bus Pin	Analog Pin	PLQP0080KB-A Pin Number
E8		P15	INT3	IDV				ADTRG	54
E9		P16	INT4	IDW					53
E10		P17	INT ₅	IDU	INPC17				52
F1	Vcc								13
F2	Vcc								13
F3		P85	NMI	SD					14
	Vss ⁽¹⁾								(11)
F9		P20			OUTC10 / INPC10 OUTC11 /		SDAMM		51
F10		P21			INPC11		SCLMM		50
G1		P84	INT ₂	ZP					15
G2		P83	INT ₁						16
G3		P82	INT 0						17
G8		P22			OUTC12 / INPC12				49
G9		P23			OUTC13 / INPC13				48
					OUTC14 /				
G10		P24			INPC14				47
H1		P81		TA4IN / U					18
H2		P80		TA40UT / U					19
H3		P71		TAOIN		RxD2 / SCL2 / CLK1			26
H4		P66				RxD1			29
H5	Vss ⁽¹⁾								(11)
H6		P35							34
H7		P32				Sout3			37
H8		P25			OUTC15 / INPC15				46
H9		P26			OUTC16 / INPC16				45
H10		P27			OUTC17 / INPC17				44
J1		P76		ΤΑзουτ					21
J2		P74		TA2OUT / W					23
J3		P72		TA10UT / V		CLK2 / RXD1			25
J4		P67				TxD1			28
J5		P64				RTS1 / CTS1/ CTS0 / CLKS1			31
J6		P36							33
J7		P33					-		36
J8		P62				RxD0			41
J9		P60				RTS0 / CTS0			41
J9 J10		P60 P61				CLK0			43
510 K1		P61 P77		ТАзіл					42 20
K2		P75		TA2IN / W TA1IN / V					22
K3		P73				$\frac{\overline{CTS_2} / \overline{RTS_2} / \overline{TXD_1}}{\frac{TXD_2}{SDA_2} / \frac{RTS_1}{SDA_2} / \frac{RTS_1}{STS_4} / \frac{CTS_2}{STS_4} / \frac{CTS_2}{STS_4} / \frac{CTS_4}{STS_4} / \frac{CTS_4}{STS$			24
K4		P70		TA00UT					27
K5		P65				CLK1			30
K6		P37							32
K7		P34							35
K8		P63				TxD0			40
K9		P30				CLK3			39
K10		P31				SIN3			38

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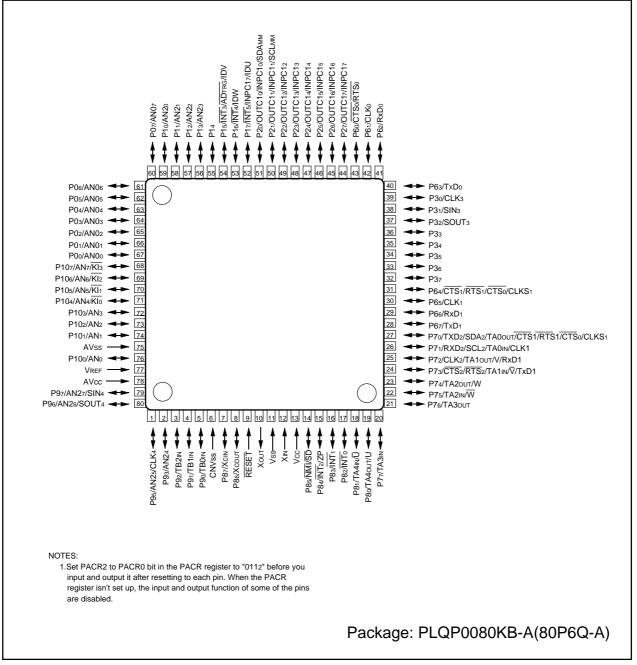


Figure 1.5 Pin Assignment (Top View) of 80-Pin Package

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	Timer S Pin	UART Pin	Multi-master I ² C bus Pin	Analog Pin
1		P95				CLK4		AN25
2		P93						AN24
3		P92		TB2IN				
4		P91		TB1IN				
5		P90		TBOIN				
6	CNVss							
7	XCIN	P87						
8	Хсоит	P86						
9	RESET							
10	Χουτ							
11	Vss							
12	Xin							
13	Vcc							
14		P85	NMI	SD				
15		P84	ĪNT2	ZP				
16		P83	INT ₁					
17		P82	INT 0					
18		P81		TA4IN / Ū				
19		P80		ТА400т / U				
20		P77		ТАзіл				
21		P76		ТАзоит				
22		P75		TA2IN / W				
23		P74		TA20UT / W				
24		P73		TA1IN / V		CTS ₂ / RTS ₂ / TxD ₁		
25		P72		TA10UT / V		CLK2 / RxD1		
26		P71		TAOIN		RxD2 / SCL2 / CLK1		
27		P70		ΤΑοουτ		TxD2 / SDA2 / RTS1 / CTS1 / CTS0 / CLKS1		
28		P67				TxD1		
29		P66				RxD1		
30		P65				CLK1		
31		P64				RTS1 / CTS1/ CTS0 / CLKS1		
32		P37						
33		P36						
34		P35						
35		P34						
36		P33						
37		P32				Sout3		
38		P31				SIN3		
39		P30				CLK3		
40		P63				TxD0		

Table 1.9 Pin Characteristics for 80-Pin Package

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	Timer S Pin	UART Pin	Multi-master I ² C bus Pin	Analog Pin
41		P62				RxD0		
42		P61				CLK0		
43		P60				RTS0 / CTS0		
44		P27			OUTC17 / INPC17			
45		P26			OUTC16 / INPC16			
46		P25			OUTC15 / INPC15			
47		P24			OUTC14 / INPC14			
48		P23			OUTC13 / INPC13			
49		P22			OUTC12 / INPC12			
50		P21			OUTC11 / INPC11		SCLMM	
51		P20			OUTC10 / INPC10		SDAMM	
52		P17	INT ₅	IDU	INPC17			
53		P16	INT4	IDW				
54		P15	INT3	IDV				ADTRG
55		P14						
56		P13						AN23
57		P12						AN22
58		P11						AN21
59		P10						AN20
60		P07						AN07
61		P06						AN06
62		P05						AN05
63		P04						AN04
64		P03						AN03
65		P02						AN02
66		P01						AN01
67		P00						AN00
68		P107	KI3					AN7
69		P106	Kl2					AN6
70		P105	KI1					AN5
71		P104	KIO					AN4
72		P103						AN3
73		P102						AN2
74		P101						AN1
75	AVss							
76		P100						AN ₀
	Vref							
78	AVcc							
79		P97				SIN4		AN27
80		P96				SOUT4		AN26

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	Timer S Pin	UART Pin	Mult-master I ² C bus Pin	Analog Pin
1		P91		TA1IN				
2		P90		ΤΒοιΝ				
3	CNVss							
4	XCIN	P87						
5	Хсоит	P86						
6	RESET							
7	Хоит							
8	Vss							
9	Xin							
10	Vcc							
11		P85	NMI	SD				
12		P84	INT ₂	ZP				
13		P83	INT ₁					
14		P82	INT 0					
15		P81		TA4IN / Ū				
16		P80		TA40UT / U				
17		P77		ТАзіл				
18		P76		ТАзоит				
19		P75		TA2IN / W				
20		P74		TA2OUT / W				
21		P73		TA1IN / V		CTS2 / RTS2 / TxD1		
22		P72		TA10UT / V		CLK2 / RxD1		
23		P71		TAOIN		RxD2 / SCL2 / CLK1		
24		P70		ΤΑοουτ		TxD2 / SDA2 / RTS1 / CTS1 / CTS0 / CLKS1		
25		P67				TxD1		
26		P66				RxD1		
27		P65				CLK1		
28		P64				RTS1 / CTS1/ CTS0 / CLKS1		
29		P33						
30		P32				Sout3		
31		P31				Sing		
32		P30				CLK3		
33		P63				TxD0		
34		P62				RxD0		
35		P61				CLK0		
36		P60				RTS0 / CTS0		
37		P27			OUTC17 / INPC17			
38		P26			OUTC16 / INPC16			
39		P25			OUTC15 / INPC15			
40		P24			OUTC14 / INPC14			

Table 1.10 Pin Characteristics for 64-Pin Package

1.6 Pin Description

Table 1.10 Pin Description (64-Pin, 80-Pin and 85-Pin Packages)

Classification	Symbol	I/O Type	Function
Power Supply	Vcc, Vss		Apply 2.7 to 5.5V to the Vcc pin. Apply 0V to the Vss pin.
Analog Power	AVcc	I	Supplies power to the A/D converter. Connect the AVcc pin to Vcc and
Supply	AVss		the AVss pin to Vss.
Reset Input	RESET	I	The MCU is in a reset state when "L" is applied to the RESET pin
CNVss	CNVss	I	Connect the CNVss pin to Vss.
Main Clock	Xin	1	I/O pins for the main clock oscillation circuit. Connect a ceramic resonato
Input			or crystal oscillator between XIN and XOUT. To apply external clock, apply
Main Clock	Хоџт	0	it to XIN and leave XOUT open. If XIN is not used (for external oscillator or
Output	7001		external clock) connect XIN pin to VCC and leave XOUT open.
Sub Clock Input	XCIN	I	I/O pins for the sub clock oscillation circuit. Connect a crystal oscillator
Sub Clock Output	Хсоит	0	between XCIN and XCOUT.
INT Interrupt	INTO to INT5	-	Input pins for the INT interrupt. INT2 can be used for Timer A Z-phase
Input			function.
NMI Interrupt	NMI	1	Input pin for the NMI interrupt. NMI cannot be used as I/O port while the three-
Input			phase motor control is enabled. Apply a stable "H" to NMI after setting it's
			direction register to "0" when the three-phase motor control is enabled.
Key Input Interrupt	KI0 to KI3	1	Input pins for the key input interrupt
Timer A	TA0OUT to	I/O	I/O pins for the timer A0 to A4
	TA40UT		
	TA0IN to	1	Input pins for the timer A0 to A4
	TA4IN		
	ZP		Input pin for Z-phase
Timer B	TB0IN to	I	Input pins for the timer B0 to B2
	TB2IN		
Three-phase	$\overline{U, \overline{U}, V, \overline{V},}$	0	Output pins for the three-phase motor control timer
Motor Control	W, W		
Timer Output	IDU, IDW,	I/O	Input and output pins for the three-phase motor control timer
	IDV, SD	1/0	
Serial I/O	CTS0 to CTS2		Input pins for data transmission control
	RTS0 to RTS2	0	Output pins for data reception control
	CLK0 to CLK3	1/0	Inputs and outputs the transfer clock
	RxD0 to RxD2	1/0	Inputs serial data
	TxD0 to TxD2	0	Outputs serial data
	CLKS1	0	Output pin for transfer clock
I ² C Mode	SDA2	1/O	Inputs and outputs serial data
	SCL2		Inputs and outputs the transfer clock
Multi-master	SDAMM	I/O	Inputs and outputs the transfer clock
I ² C bus	SCLMM	0	Inputs and outputs serial data Inputs and outputs the transfer clock
Reference	VREF	1	Applies reference voltage to the A/D converter
Voltage Input	VILE		Applies relevence voltage to the A/D converter
A/D Converter	AN0 to AN7	1	Analog input pins for the A/D converter
Converter	AN0 to AN03		
	AN00 to AN03 AN24		
	AINZ4		Input pin for an external A/D trigger
: Input O :			and output

I : Input O : Output I/O : Input and output

Classification	Symbol	I/O Type	Function
Timer S	INPC10 to INPC17	I	Input pins for the time measurement function
	OUTC10 to OUTC17	0	Output pins for the waveform generating function
I/O Ports	P00 to P03	I/O	I/O ports for CMOS. Each port can be programmed for input or output
	P15 to P17		under the control of the direction register. An input port can be set, by
	P20 to P27		program, for a pull-up resistor available or for no pull-up resister available
	P30 to P33		in 4-bit units
	P60 to P67		
	P70 to P77		
	P80 to P87		
	P100 to P107		
	P90 to P93	I/O	I/O ports having equivalent functions to P0

Table 1.10 Pin Description (64-Pin, 80-Pin and 85-Pin Packages) (Continued)

I : Input O : Output I/O : Input and output

3. Memory

Figure 3.1 is a memory map of the M16C/28 Group (M16C/28, M16C/28B). M16C/28 Group provides 1-Mbyte address space from addresses 0000016 to FFFF16. The internal ROM is allocated lower addresses beginning with address FFFF16. For example, 64 Kbytes internal ROM is allocated addresses F000016 to FFFFF16.

Two 2-Kbyte internal ROM areas, block A and block B, are available in the flash memory version. The blocks are allocated addresses F00016 to FFFF16.

The fixed interrupt vector tables are allocated addresses FFFDC16 to FFFFF16. It stores the starting address of each interrupt routine. See the section on interrupts for details.

The internal RAM is allocated higher addresses beginning with address 0040016. For example, 4-Kbytes internal RAM is allocated addresses 0040016 to 013FF16. Besides storing data, it becomes stacks when the subroutine is called or an interrupt is acknowledged.

SFR, consisting of control registers for peripheral functions such as I/O port, A/D converter, serial I/O, timers is allocated addresses 0000016 to 003FF16. All blank spaces within SFR are reserved and cannot be accessed by users.

The special page vector table is allocated to the addresses FFE0016 to FFFDB16. This vector is used by the JMPS or JSRS instruction. For details, refer to the *M16C/60 and M16C/20 Series Software Manual*.

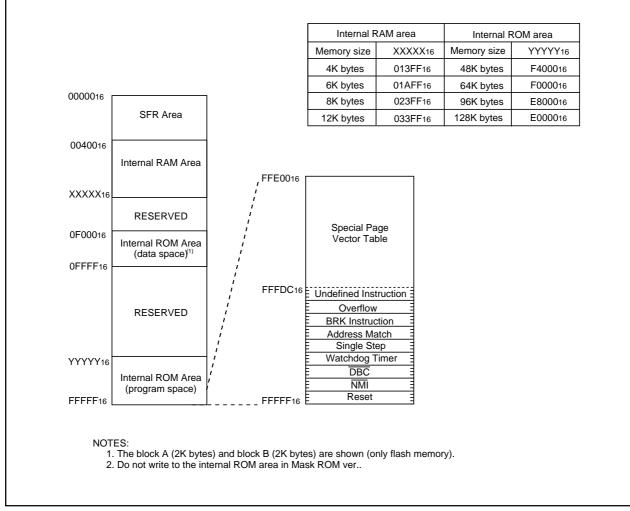


Figure 3.1 Memory Map



4. Special Function Register (SFR)

SFR (Special Function Register) is the control register of peripheral functions. Tables 4.1 to 4.7 list the SFR information.

Table 4.1 SFR Information(1)⁽¹⁾

Address	Register	Symbol	After Reset		
000016					
000116					
000216					
000316					
000416	Processor mode register 0	PM0	PM0 0016		
000516	Processor mode register 1	PM1 000010002			
000616	System clock control register 0	CMO	010010002		
000716	System clock control register 1	CM1	001000002		
000816					
000916	Address match interrupt enable register	AIER XXXXXX002			
000A16	Protect register	PRCR XX0000002			
000B16					
000C16	Oscillation stop detection register (2)	CM2	0X0000102		
000D16					
000E16	Watchdog timer start register	WDTS	XX16		
000F16	Watchdog timer control register	WDC	00XXXXXX2		
001016	Address match interrupt register 0	RMAD0	0016		
001116			0016		
001216			X016		
001316			0010		
001416	Address match interrupt register 1	RMAD1	0016		
001516			0016		
001616			X016		
001716					
001816	Voltage detection register (/2)	1/054	000040000		
001916 001A16	Voltage detection register 1 ⁽³⁾	VCR1	000010002		
	Voltage detection register 2 (3)	VCR2	0016		
001B16	DLL control register 0	DI CO	0004 ¥0400		
001C16 001D16	PLL control register 0	PLC0	0001X0102		
	Dressess mode register 2	DM2			
001E16 001F16	Processor mode register 2	PM2 XXX000002			
001F16	Low voltage detection interrupt register	D4INT	0016		
002016	DMA0 source pointer	SAR0	XX16		
002116			XX16 XX16		
002216					
002016	DMA0 doctingtion pointer	DAR0	XX16		
002516	DMA0 destination pointer	DARU	XX16		
002616			XX16		
002716					
002816	DMA0 transfer counter	TCR0	XX16		
002916		TCRO	XX16 XX16		
002016					
002B16					
002C16	DMA0 control register	DM0CON	00000X002		
002D16		DIVIOCON			
002E16					
002F16					
003016	DMA1 source pointer	SAR1	XX16		
003116		OAN	XX16		
003216			XX16		
003316					
003416	DMA1 destination pointer	DAR1	XX16		
003516		Britti	XX16 XX16		
003616			XX16		
003716					
003816	DMA1 transfer counter	TCR1	XX16		
003916			XX16		
003A16					
003B16					
003C16	DMA1 control register	DM1CON	00000X002		
003D16		DivitCOIN	000007002		
003E16					

NOTES:

The blank spaces are reserved. No access is allowed.
 The CM20, CM21, and CM27 bits do not change at oscillation stop detection reset.

3. This register does not change at software reset, watchdog timer reset and oscillation stop detection reset.

X : Undefined

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Table 4.3 SFR Information(3)⁽¹⁾

Address	Register	Symbol	After Reset	
01B016				
01B116				
01B216				
01B316	Flash memory control register 4 (2)	FMR4	01000002	
01B416	-			
01B516 01B616	Flash memory control register 1 (2)	FMR1	000XXX0X2	
01B016 01B716	Flash memory control register 0 (2)	FMR0 000000012		
01B816		FMRO	00000012	
01B916				
:				
021016	Low-power Consumption Control 0	LPCC0	X0000012	
021116				
021216				
021316				
021416 021516				
021516				
021018				
021716				
021916				
:				
025016				
025116				
025216				
025316				
025416 025516				
025516				
025016				
025816				
025916				
025A16				
025B16				
025C16	On-chip oscillator control register	ROCR	X00001012	
025D16	Pin assignment control register	PACR	0016	
025E16	Peripheral clock select register	PCLKR	000000112	
025F16	Low-power Consumption Control 1	LPCC1	0016	
:				
0050				
02E016	I ² C0 data shift register	S00	XX16	
02E116	1 ² 00 address register	0000	0010	
02E216 02E316	I ² C0 address register I ² C0 control register 0	<u>S0D0</u>	0016	
02E316	I ² C0 clock control register	<u>S1D0</u> S20	0016 0016	
02E416	I ² C0 start/stop condition control register	S20	00016	
02E516	I ² C0 control register 1	S3D0	001100002	
02E716	I ² C0 control register 2	S4D0	001100002	
02E716	I ² C0 status register	S10	0001000X2	
02E916				
02EA16				
:				
02FE16				
02FF16				

Note 1:The blank spaces are reserved. No access is allowed. Note 2:This register is included in the flash memory version.

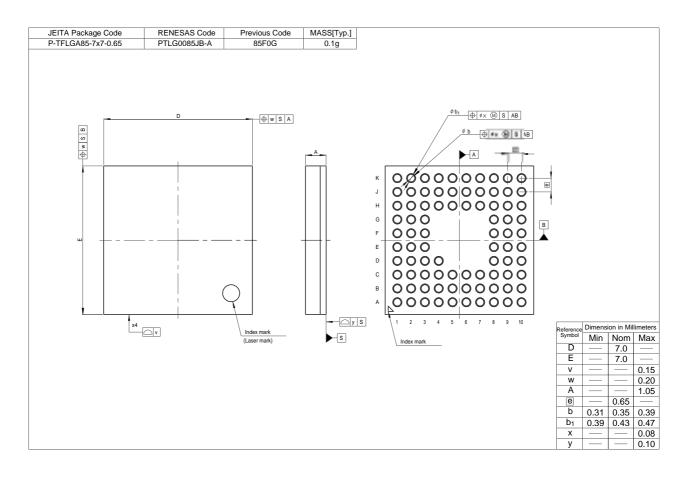
X : Undefined

Table 4.4 SFR Information(4)⁽¹⁾

ddress	Register	Symbol	After Reset
030016	TM, WG register 0	G1TM0, G1PO0	XX16
030116			XX16
030216	TM, WG register 1	G1TM1, G1PO1	XX16
030316			XX16
030416	TM, WG register 2	G1TM2, G1PO2	XX16
030516			XX16
030616	TM, WG register 3	G1TM3, G1PO3	XX16
030716			XX16
030816	TM, WG register 4	G1TM4, G1PO4	XX16
030916			XX16
030A16	TM, WG register 5	G1TM5, G1PO5	XX16
030B16			XX16
030C16	TM, WG register 6	G1TM6, G1PO6	XX16
030D16			XX16
030E16	TM, WG register 7	G1TM7, G1PO7	XX16
030F16			XX16
031016	WG control register 0	G1POCR0	0X00XX002
031116	WG control register 1	G1POCR1	0X00XX002
031216	WG control register 2	G1POCR2	0X00XX002
031316	WG control register 3	G1POCR3	0X00XX002
031416	WG control register 4	G1POCR4	0X00XX002
031516	WG control register 5	G1POCR5	0X00XX002
031616	WG control register 6	G1POCR6	0X00XX002
031716	WG control register 7	G1POCR7	0X00XX002
031816	TM control register 0	G1TMCR0	0016
031916	TM control register 1	G1TMCR1	0016
031A16	TM control register 2	G1TMCR2	0016
031B16	TM control register 3	G1TMCR3	0016
031C16	TM control register 4	G1TMCR4	0016
031D16	TM control register 5	G1TMCR5	0016
031E16	TM control register 6	G1TMCR6	0016
031F16	TM control register 7	G1TMCR7	0016
032016	Base timer register	G1BT	XX16
032116			XX16
032216	Base timer control register 0	G1BCR0	0016
032316	Base timer control register 1	G1BCR1	0016
032416	TM prescale register 6	G1TPR6	0016
032516	TM prescale register 7	G1TPR7	0016
032616	Function enable register	G1FE	0016
032716	Function select register	G1FS	0016
032816	Base timer reset register	G1BTRR	XX16
032916			XX16
032A16	Divider register	G1DV	0016
032B16			
032C16			
032D16			
032E16			
032F16			
033016	Interrupt request register	G1IR	XX16
033116	Interrupt enable register 0	G1IE0	0016
033216	Interrupt enable register 1	G1IE1	0016
033316			
033416			
033516			
033616			
033716			
033816			
033916			
033A16			
033B16			
033C16			
033D16			FF
033E16	NMI digital debounce register	NDDR	FF16
033F16	P17 digital debounce register	P17DDR	FF16

Note 1:The blank spaces are reserved. No access is allowed.

X : Undefined



REVISION HISTORY

M16C/28 Group (M16C/28, M16C/28B) Shortsheet

Rev.	Date		Description
Nev.	Dale	Page	Summary
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